

George C. Marshall Space Flight Center
Marshall Space Flight Center, Alabama
35812

Reply to Attn of: EB34 (04-89)

April 8, 1989

TO: EB34/J. Blanche

From: EB34/D. Jones

Subject: Tantalum Capacitor Vibration Test

A vibration test of axial-lead, solid tantalum capacitors was conducted to gain quantitative data to support staking requirements defined in NASA documents NHB 5300.4(3J) and NHB 5300.4(3K). The test was initiated to resolve the incompatibility between the previously mentioned documents and the .5 ounce weight requirement designated by NHB 5300.4(3A-1). Even though these parts have a long history of high-cycle fatigue failures of the leads, the available failure records often fail to identify case size and/or vibration level. This test was conducted under controlled conditions. The results support the need for staking axial-lead, solid tantalum capacitors regardless of case size.

Three identical 5"X7" printed wiring boards(PWB) were designed and populated with 96 axial-lead, solid tantalum capacitors. Each PWB held 8 of each case size. Wedglock card retainers held the PWBs rigidly in position (see fig. 1). The location of capacitor groups would show any difference in amplification of vibration on the PWB. The capacitors were not staked, nor were they conformally coated since a .004" thick coating provides no structural support.

TABLE 1. TANTALUM CAPACITOR PARTS LIST

CASE SIZE	P/N(MIL-C-39003/1E)	LEAD DIAMETER(+.002)
A	-3003J	.020
B	-3024J	.020
C	-2981J	.025
	-3012J	.025
D	-3032J	.025
	-6556	.025

The test fixture was a 200 lb. magnesium cube with three orthogonally attached channeled brackets. The brackets were positioned in the X,Y,and Z planes so that each PWB would experience vertical vibration in its respective axis(see fig. 2). The test was run on a T 4000 shaker.

The PWBs were subjected to a series of random vibration test levels over the range of 3.5 to 49.32 GRMS in approximately 2 GRMS increments. The shape of the curve selected was the Shuttle Cargo Bay Equipment acceptance test criteria which has a composite of 6.1 GRMS. The PWB were vibrated for a duration of 120 seconds at each level. The vibrational input to the PWBs was controlled by an accelerometer mounted on the cube between the test articles(see fig. 2).

ACCEPTANCE TEST CRITERIA

	20 Hz @ 0.01 g ² /Hz
20 -	80 Hz @ +3 dB/oct
80 -	350 Hz @ 0.04 g ² /Hz
350 -	2000 Hz @ -3dB/oct
	2000 Hz @ 0.007 g ² /Hz

All vibration test levels represent dynamic input directly to the PWBs. Discussions with vibration personnel in Structures and Dynamics Laboratory, and Bendix Guidance and Control Division indicate that board level vibrations will exceed box level inputs by a factor of three to seven depending upon the black box design. The axis perpendicular to the plane of the board is the most sensitive to vibration. The tantalum capacitor leads showed physical deformation at board input levels as low as 6.1 GRMS. C and D case capacitor leads(Z-AXIS) BROKE AT 11.99 GRMS. On the next run the same C and D case capacitors were torn completely from the PWB. The first A and B case capacitor failures were recorded at 17.97 GRMS. The B case capacitor broke both leads simultaneously and was catapulted completely from the PWB. A PWB could experience an input vibration of 18 GRMS with a box input vibration between 3 GRMS and 6 GRMS which is below the Shuttle Cargo Bay Equipment acceptance test level. Subsequent vibrations yielded many more lead breaks(see test data).

TABLE 2. FAILURE SUMMARY

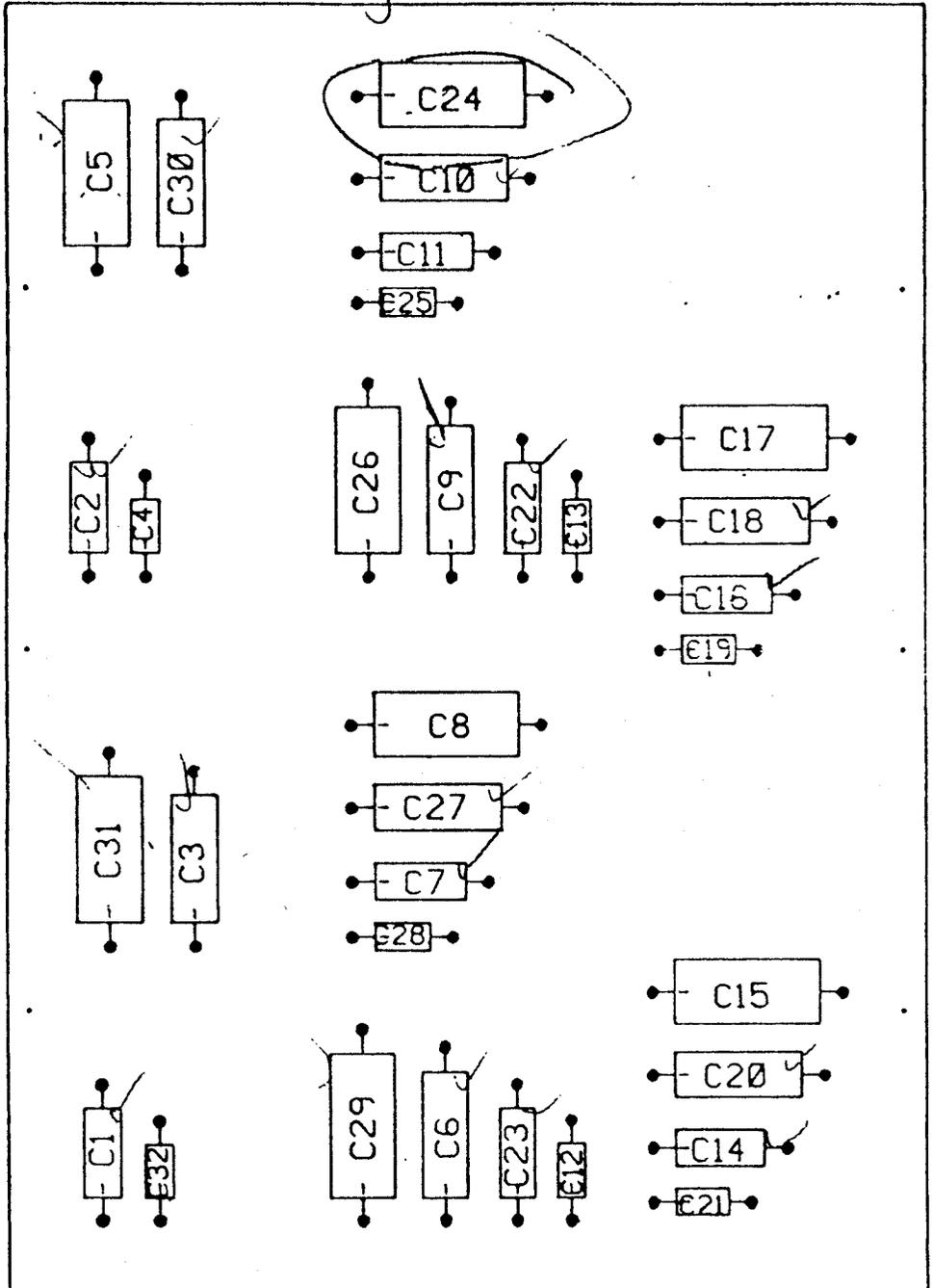
	X-AXIS	Y-AXIS	Z-AXIS
CASE SIZE			
A	0	0	2
B	0	0	8
C	3	5	8
D	5	5	8

8 10 26 TOTAL BY AXIS
 44 TOTAL
 47.8% FAILURE RATE

As theorized unstaked, axial-lead, solid tantalum capacitors fail under vibration. Not only is electrical continuity lost but shorting may also occur from loose parts on the PWB. The test data supports the staking requirements for all axial-lead, solid tantalum capacitors identified in NHB 5300.4(3J), section 3J602.4 and NHB 5300.4(3K), section 3K506.7. It is recommended that waivers and deviations to these requirements be disapproved.

FIGURE 1

Fig. 1



TEST SETUP SKETCH

FIGURE 2 (a)

Vertical Axis

3 SPECIMEN TEST

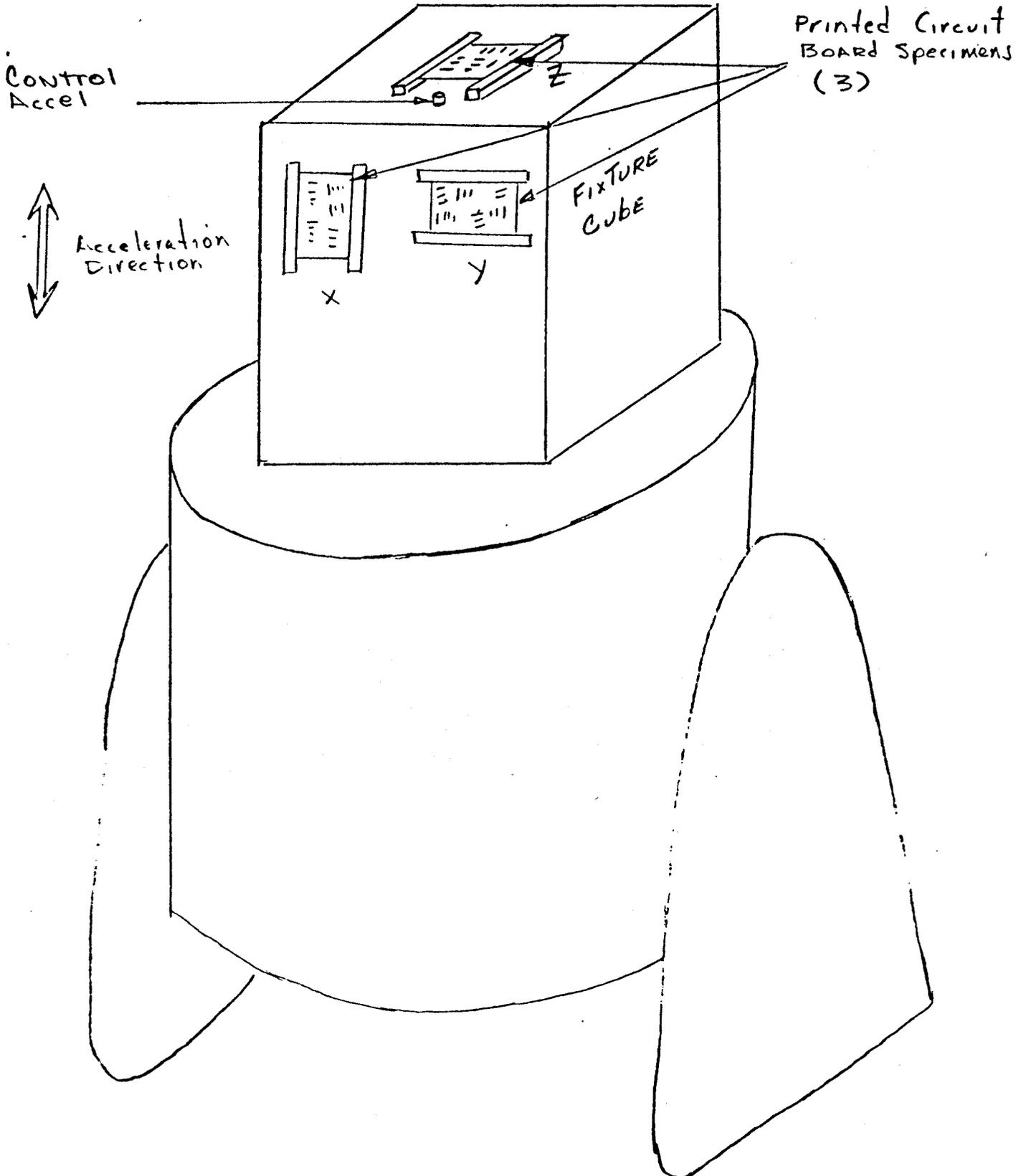


FIGURE 2 (b)

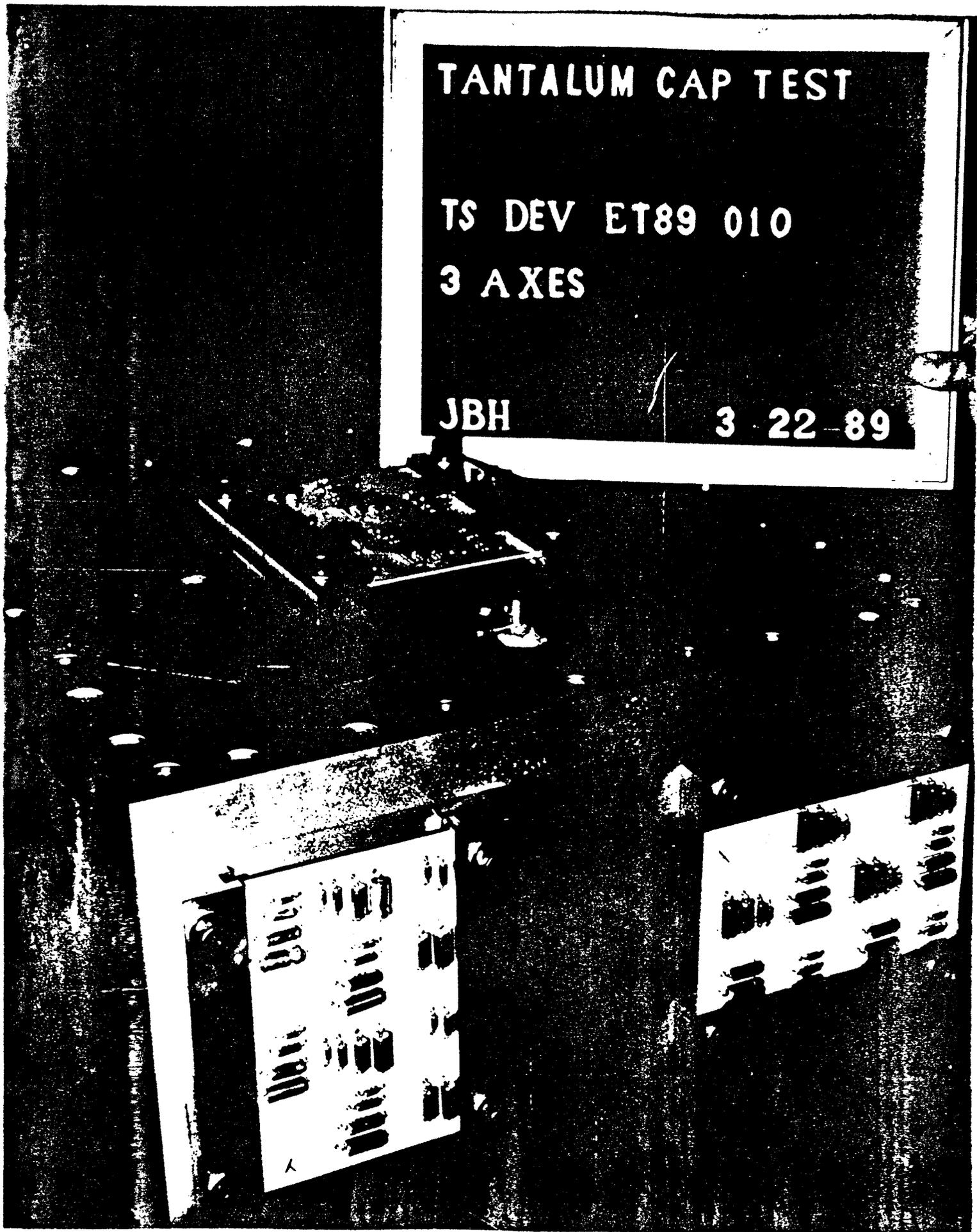


TABLE 3. FAILURE DATA

CASE	I/D	COMPOSITE G LEVELS (TOTAL VIB. TIME IN MIN.)			
		X-AXIS	Y-AXIS	Z-AXIS	
A	C04				
	C12				
	C13				
	C19				
	C21				
	C25			28.04 (28)	
	C28			17.97 (17)	
	C32				
B	C01			49.32 (48)	
	C02			35.73 (36)	
	C07			17.97 (18)	
	C11			34.42 (34)	
	C14			40.50 (40)	
	C16			37.75 (38)	
	C22			31.94 (32)	
	C23			31.94 (32)	
C	C03	31.94 (32)		34.42 (32)	
	C06		49.32 (48)	30.20 (30)	
	C09	40.50 (40)		23.92 (24)	
	C10		35.73 (36)	22.05 (22)	
	C18		40.50 (40)	34.42 (34)	
	C20		34.42 (34)	35.73 (36)	
	C27		23.92 (24)	11.94 (12)	
	C30	34.42 (34)		40.50 (40)	
	D	C05	17.97 (18)		22.05 (22)
		C08		13.99 (14)	11.94 (12)
C15			15.90 (16)	22.05 (22)	
C17		37.75 (38)		31.94 (32)	
C24			30.20 (30)	15.90 (16)	
C26		34.42 (34)		17.97 (18)	
C29		23.92 (24)	19.91 (20)	19.91 (20)	
C31		17.97 (18)		28.04 (28)	

G LEVEL	CAP ID	VIB TIME	DESCRIPTION
3.481		2	All is well (AIW)
5.025		4	(AIW)
6.543		6	(AIW) Few Bands
7.536		8	(AIW)
9.762		10	
	C27/C	12	Erosion at solder joint (z-axis)
11.94	C8/D		" " " " "
13.79	C27/C	14	2nd Break close to solder joint } z-axis
	C8/D		" " " " " }
	C8/D		Break at body (y-axis)
15.40	C15/D	16	Break at body (y-axis)
	C24/D		" " " (z-axis)
17.57	C7/E	17	Extr. traces at solder joints (z-axis)
	C15/D		2nd Break at close to body (y-axis)
	C28/A		One break at solder joint away from z (z-axis)
	C26/D		Break at body (z-axis)
	C5/D		Break at body (x-axis)
	C31/D		" "

G LEVEL	CAP ID	VIB TIME	DESCRIPTION
19.91	C28/D	20	2nd Break at body (y-axis)
	C29/D		Breaks at body + solder joint (y-axis)
	C24/D		" " " " " (z-axis)
22.05	C15/D	22	Breaks at body + solder joint (z-axis)
	C10K		Breaks at solder joints (z-axis)
	C5/D		Break at body (z-axis)
23.92	C17/D	24	Break at solder joint (y-axis)
	C27/C		Break at body (y-axis)
	C29/D		Break at body (x-axis)
	C5/D		2nd break lead at bend (z-axis)
	C9K		Break at body (z-axis)
26.53	C97C	26	2nd Break at solder joint (z-axis)
	C5/D		" " " " " (x-axis)
	C31/D		" " " " " (x-axis)
28.24	C17/D	28	2nd Break at solder (y-axis)
	C27/C		" Break at solder "
	C29/D		Break at solder (y-axis)
	C25/A		Break at solder (z-axis)
	C31/L		Break at body (z-axis)

G LEVEL	CAP ID	VIB TIME	DESCRIPTION	
30.20	C24/D C6/C	30	2nd Break in lead (y-axis) 1 Break at solder + body (z-axis)	
31.94 *	C23/B C22/B C17/D C3/C	32	Breaks at body " " " + solder " " " " Break at body	Z-axis ✓ Z-axis Z-axis X-axis
34.42	C3/C C4/C C3/C C26/D C20/C C11/B C20/C	34	Break at body + solder break at body + body 1 break lead break at body Break at solder Break in lead Break at body	Z-axis Z-axis X-axis X-axis Y-axis Z-axis X-axis
35.73 →	C26/D C10/E C2/E C20/C C31/E	35	2nd Break Break at body + lead Break at body Break at solder	X-axis Y-axis Z-axis Z-axis Z-axis

